

2SC1890A

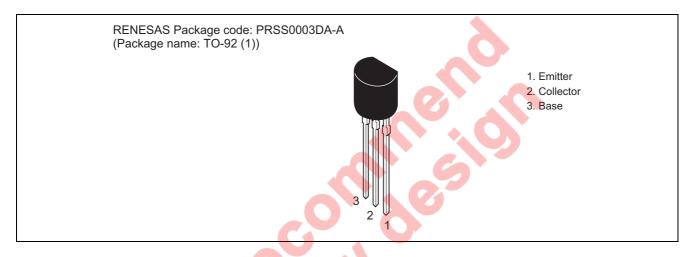
Silicon NPN Epitaxial

REJ03G0692-0200 (Previous ADE-208-1057) Rev.2.00 Aug.10.2005

Application

- Low frequency high voltage amplifier
- Complementary pair with 2SA893A

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	120	V
Collector to emitter voltage	V _{CEO}	120	V
Emitter to base voltage	V _{EBO}	5	V
Collector current	Ic	50	mA
Collector power dissipation	P _C	300	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Electrical Characteristics

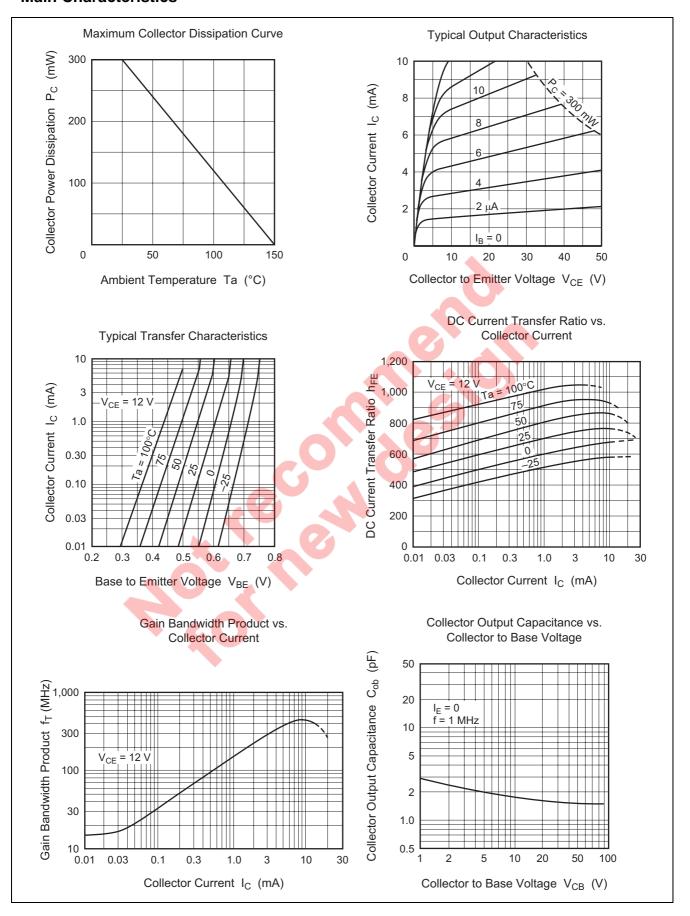
 $(Ta = 25^{\circ}C)$

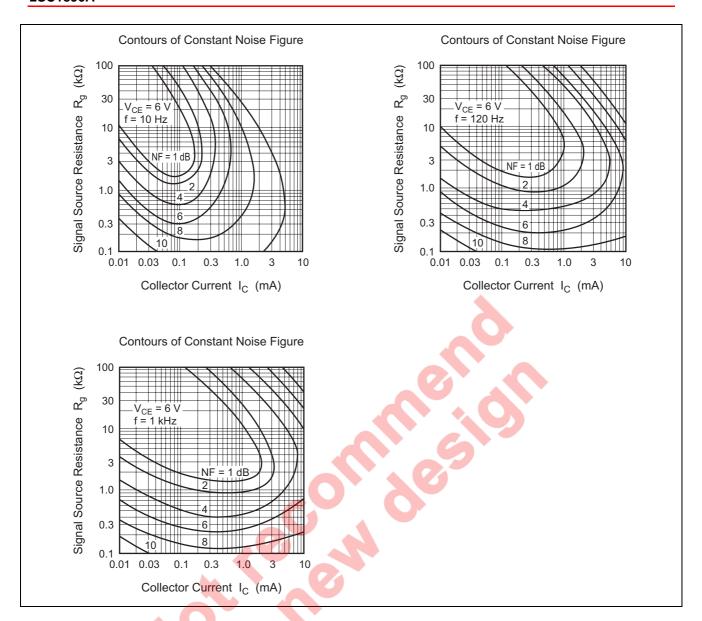
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	120	_	_	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Collector cutoff current	I _{CBO}	_	_	_	μΑ	$V_{CB} = 75 \text{ V}, I_{E} = 0$
		_	_	0.5	μΑ	$V_{CB} = 100 \text{ V}, I_E = 0$
DC current transfer ratio	h _{FE} *1	250	_	1200		V _{CE} = 12 V, I _C = 2 mA
Base to emitter voltage	V_{BE}	_	_	0.75	V	V _{CE} = 12 V, I _C = 2 mA
Collector to emitter saturation voltage	V _{CE(sat)}	_	_	0.5	V	$I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$
Gain bandwidth product	f⊤	_	200	_	MHz	$V_{CE} = 12 \text{ V}, I_{C} = 2 \text{ mA}$
Collector output capacitance	Cob	_	1.6	_	pF	$V_{CB} = 25 \text{ V}, I_E = 0,$
						f = 1 MHz
Noise figure	NF	_	2	10	dB	$V_{CE} = 6 \text{ V}, I_{C} = 50 \mu\text{A},$
						$R_g = 50 \text{ k}\Omega, f = 1 \text{ kHz}$

Note: 1. The 2SC1890A is grouped by h_{FE} as follows.

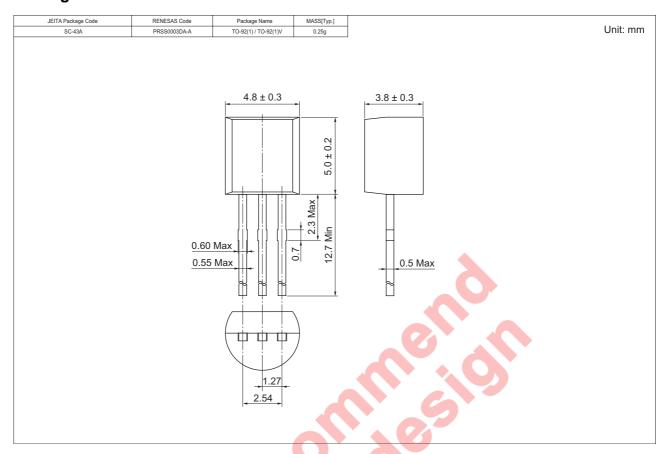
	1		
D	E	F	
250 to 500	400 to 800	600 to 1200	

Main Characteristics





Package Dimensions



Ordering Information

Part Name		Quantity	Shipping Container
2SC1890ADTZ	2500		Hold Box, Radial Taping
2SC1890AETZ	94		
2SC1890AFTZ			

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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